



Recommended P.C.B. Layout
Layout Tolerance = ± 0.05 mm

NOTE:

- MATERIAL,
HOUSING: HIGH TEMP PLASTIC, UL94-V0, BLACK
TERMINAL: COPPER ALLOY, SQ=0.40±0.03MM
- FINISH:
TERMINAL: GOLD AT CONTACT,
G/F OVER 1um(40u") MIN Ni OVER ALL
- SPEC.:
PRODUCT SPEC: GS-12-629
PACKING SPEC: GS-14-1420
- THE HSG. WILL WITHSTAND EXPOSURE TO 260C
PEAK TEMP. FOR 5 SEC. IN A WAVE SOLDER APPLICATION
WITH A PCB.
- PRODUCT NUMBERING:
20021111 - 0 0 0 XX X X LF

LEAD FREE
PLATING:
1: GOLD FLASH ALL OVER
4: 0.25um(10U") GOLD AT CONTACT
8: 0.76um(30U") GOLD AT CONTACT
9: 1u" GOLD OVER 30u" PdNi AT CONTACT
PACKING
T: TUBE

PIN COUNT
06,08,10, ..., 98,A0
(6 -100 EVERY EVEN PIN)

mat'l. code		surface ISO1302 ✓		tolerance ISO1101 ISO406		projection ① ②		product family MINITEK	
l t r e c n n o d r		date		tolerances unless otherwise specified		MM		title	
A	T09-1117	S.LIN	09/15/09	angle	0.X±0.38	scale 8:1		1.27X1.27MM BTB HEADER UNSHROUDED VERTICAL TH	
B	T10-0011	S.LIN	01/22/10	0°±2'	0.XX±0.25			dwg no	
C	BX-N-010355	ZK	01/18/12		0.XXX±0.10			sheet 1 of 1	
				dr	STERLING LIN	09/15/09	FCI		size
				engr	STERLING LIN	09/15/09	20021111		A4
				chr	GRAY HSIEH	09/15/09	type		Product Customer Drawing
				appd	JOSEPH	09/15/09			
sheet index	revision	cnc sheet							